



Features

- Two or four channels of ESD protection
- Provides ESD protection to IEC61000-4-2 Level 4
 - ±8kV contact discharge
- Low channel input capacitance of 0.7pF typical
- Minimal capacitance change with temperature and voltage
- Channel input capacitance matching of 0.02pF typical is ideal for differential signals
- Zener diode protects supply rail and eliminates the need for external by-pass capacitors
- Low clamping voltage (V_{CLAMP}) at 10V
- Low Dynamic resistance (R_{DYN}) at 1.08 Ω
- Each I/O pin can withstand over 1000 ESD strikes*
- Available in SOT and MSOP lead-free packages

Applications

- USB 2.0 ports at 480Mbps in desktop PCs, notebooks and peripherals
- IEEE1394 Firewire® ports at 400Mbps / 800Mbps
- DVI ports, HDMI ports in notebooks, set top boxes, digital TVs, LCD displays
- Serial ATA ports in desktop PCs and hard disk drives
- PCI Express ports
- General purpose high-speed data line ESD protection

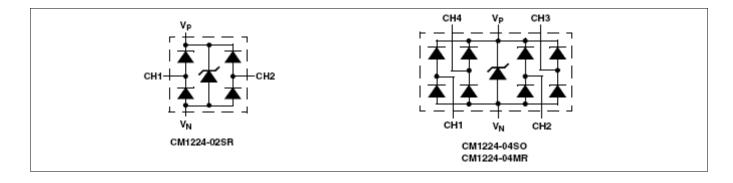
Block Diagram

Product Description

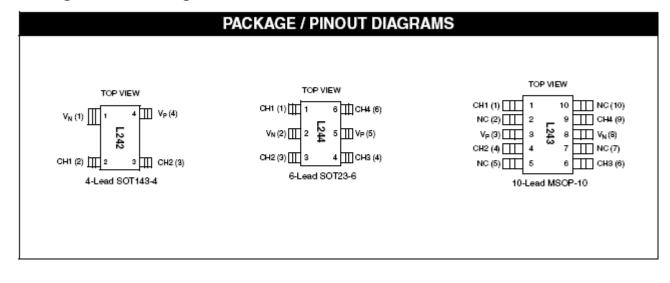
The CM1224 family of diode arrays has been designed to provide ESD protection for electronic components or subsystems requiring minimal capacitive loading. These devices are ideal for protecting systems with high data and clock rates or for circuits requiring low capacitive loading. Each ESD channel consists of a pair of diodes in series which steer the positive or negative ESD current pulse to either the positive (V_p) or negative (V_N) supply rail. A Zener diode is embedded between V_p and V_N , offering two advantages. First, it protects the V_{cc} rail against ESD strikes, and second, it eliminates the need for a bypass capacitor that would otherwise be needed for absorbing positive ESD strikes to ground. The CM1224 protects against ESD pulses up to ±8kV per the IEC 61000-4-2 standard.

These devices are particularly well-suited for protecting systems using high-speed ports such as USB 2.0, IEEE1394 (Firewire®, iLink[™]), Serial ATA, DVI, HDMI and corresponding ports in removable storage, digital camcorders, as well as DVD-RW drives and other applications where extremely low loading capacitance with ESD protection are required.

The CM1224 family of devices has lead-free finishing in a small package footprint.



Package/Pinout Diagrams



Pin Configuration

| | 2-CH | IANNEL, 4-LI | EAD SOT143-4 PACKAGE | |
|------------------------------------|----------------|--------------|------------------------------|--|
| PIN | NAME | TYPE | DESCRIPTION | |
| 1 | V _N | GND | Negative voltage supply rail | |
| 2 | CH1 | I/O | ESD Channel | |
| 3 | CH2 | I/O | ESD Channel | |
| 4 | V _P | PWR | Positive voltage supply rail | |
| 4-CHANNEL, 6-LEAD SOT23-6 PACKAGES | | | | |
| PIN | NAME | TYPE | DESCRIPTION | |
| 1 | CH1 | I/O | ESD Channel | |
| 2 | V _N | GND | Negative voltage supply rail | |
| 3 | CH2 | I/O | ESD Channel | |
| 4 | CH3 | I/O | ESD Channel | |
| 5 | V _P | PWR | Positive voltage supply rail | |
| 6 | CH4 | I/O | ESD Channel | |

| | 4-CHANNEL, 10-LEAD MSOP-10 PACKAGES | | | | | | |
|-----|-------------------------------------|------|------------------------------|--|--|--|--|
| PIN | NAME | TYPE | DESCRIPTION | | | | |
| 1 | CH1 | I/O | ESD Channel | | | | |
| 2 | NC | | No Connect | | | | |
| 3 | V _P | PWR | Positive voltage supply rail | | | | |
| 4 | CH2 | I/O | ESD Channel | | | | |
| 5 | NC | | No Connect | | | | |
| 6 | CH3 | I/O | ESD Channel | | | | |
| 7 | NC | | No Connect | | | | |
| 8 | V _N | GND | Negative voltage supply rail | | | | |
| 9 | CH4 | I/O | ESD Channel | | | | |
| 10 | NC | | No Connect | | | | |

Ordering Information

| PART NUMBERING INFORMATION | | | | | | | |
|----------------------------|-------|----------|-----------------------------------|--------------|--|--|--|
| | | | Lead-free Finish | | | | |
| # of Channels | Leads | Package | Ordering Part Number ¹ | Part Marking | | | |
| 2 | 4 | SOT143-4 | CM1224-02SR | L242 | | | |
| 4 | 6 | SOT23-6 | CM1224-04SO | L244 | | | |
| 4 | 10 | MSOP-10 | CM1224-04MR | L243 | | | |

Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

Specifications

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|--|--|-------|--|--|--|
| PARAMETER | RATING | UNITS | | | |
| Operating Supply Voltage ($V_{P} - V_{N}$) | 6.0 | V | | | |
| Operating Temperature Range | -40 to +85 | C° | | | |
| Storage Temperature Range | -65 to +150 | °C | | | |
| DC Voltage at any channel input | (V _N - 0.5) to (V _P + 0.5) | V | | | |

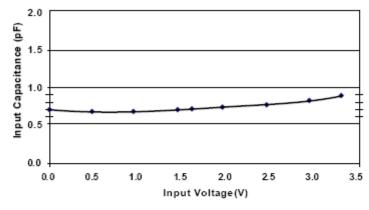
| STANDARD OPERATING CONDITIONS | | | | | | |
|---|------------|----------|--|--|--|--|
| PARAMETER | RATING | UNITS | | | | |
| Operating Temperature Range | -40 to +85 | °C | | | | |
| Package Power Rating SOT23-3, SOT143-4,SOT23-5 and SOT23-6 Packages MSOP-10 Package | 225 400 | mW mW | | | | |

| | ELECTRICAL OPERATING CHARACTERISTICS ^(SEE NOTE 1) | | | | | | | | |
|-------------------|---|---|--------------|---------------|--------------|-------------|--|--|--|
| SYMBOL | PARAMETER | CONDITIONS | MIN | ТҮР | MAX | UNITS | | | |
| V _P | Operating Supply Voltage $(V_{P}-V_{N})$ | | | 3.3 | 5.5 | V | | | |
| I _P | Operating Supply Current | (V _P -V _N)=3.3V | | | 8.0 | μA | | | |
| V _F | Diode Forward Voltage Top Diode Bottom Diode | I _F = 8mA; T _A =25 °C | 0.60 0.60 | 0.80 0.80 | 0.95 0.95 | V V | | | |
| I _{leak} | Channel Leakage Current | T _A =25 °C; V _P =5V, V _N =0V | | ±0.1 | ±1.0 | μA | | | |
| C _{IN} | Channel Input Capacitance | At 1 MHz, $V_p=3.3V$, $V_N=0V$, $V_{IN}=1.65V$ | 0.60 | 0.70 | 0.80 | pF | | | |
| ΔC_{IN} | Channel Input Capacitance Matching | At 1 MHz, V_p =3.3V, V_N =0V, V_{IN} =1.65V | | 0.02 | | pF | | | |
| V _{ESD} | ESD Protection - Peak Discharge Voltage at any channel input, in system Contact discharge per IEC 61000-4-2 standard | Notes 2 and 3; $T_A=25 ^{\circ} C$ | ±8 | | | kV | | | |
| V _{CL} | Channel Clamp Voltage Positive Transients Negative Transients | $T_{A} = 25 \text{ °C}, I_{PP} = 1A,$ $t_{P} = 8/20 \mu \text{S}; \text{ Note } 3$ | | +10.0 -1.8 | | V V V | | | |
| R _{dyn} | Dynamic Resistance Positive Transients Negative Transients | $I_{PP} = 1A$, $t_P = 8/20\mu S$ Any I/O pin to Ground; Note 3 | | 1.08 0.66 | | Ω Ω | | | |

Note 1: All parameters specified at $T_{_A}$ = -40 °C to +85 °C unless otherwise noted. Note 2: Standard IEC 61000-4-2 with $C_{_{Discharge}}$ = 150pF, $R_{_{Discharge}}$ = 330 Ω , $V_{_P}$ = 3.3V, $V_{_N}$ grounded. Note 3: These measurements performed with no external capacitor on $V_{_P}$ ($V_{_P}$ floating).

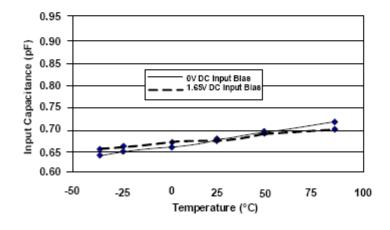
Performance Information

Input Channel Capacitance Performance Curves





(f=1MHz, Vp = 3.3V, V_N = 0V, 10k Ω between Vp and 3.3V supply, 0.1 μ F chip capacitor between Vp and V_N, 25°C)



Typical Variation of C_{IN} vs. Temp

(f=1MHz, V_{IN}=30mV, V_P = 3.3V, V_N = 0V,10kΩ between V_P and 3.3V supply, 0.1 μ F chip capacitor between V_P and V_N)

Performance Information (cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)

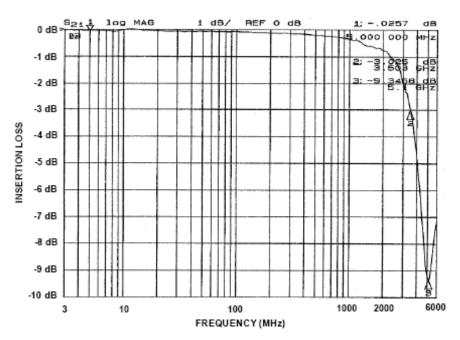


Figure 1. Insertion Loss (S21) VS. Frequency (0V DC Bias, V_p=3.3V)

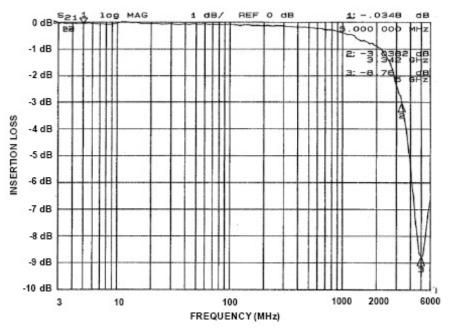


Figure 2. Insertion Loss (S21) VS. Frequency (2.5V DC Bias, V_p =3.3V)

Application Information

Design Considerations

To realize the maximum protection against ESD pulses, care must be taken in the PCB layout to minimize parasitic series inductances on the Supply/ Ground rails as well as the signal trace segment between the signal input (typically a connector) and the ESD protection device. Application of Positive ESD Pulse between Input Channel and Ground illustrates an example of a positive ESD pulse striking an input channel. The parasitic series inductance back to the power supply is represented by L_1 and L_2 . The voltage V_{CL} on the line being protected is:

where I_{ESD} is the ESD current pulse, and V_{SUPPLY} is the positive supply voltage.

An ESD current pulse can rise from zero to its peak value in a very short time. As an example, a level 4 contact discharge per the IEC61000-4-2 standard results in a current pulse that rises from 0 to 30 Amps in 1ns. Here $d(I_{ESD})/dt$ can be approximated by $\Delta I_{ESD}/\Delta t$, or $30/(1 \times 10^{-9})$. So just 10nH of series inductance (L₁ and L₂ combined) will lead to a 300V increment in V_{cl}!

Similarly for negative ESD pulses, parasitic series inductance from the V_{N} pin to the ground rail will lead to drastically increased negative voltage on the line being protected.

The CM1224 has an integrated Zener diode between V_p and V_N . This greatly reduces the effect of supply rail inductance L_p on V_{cL} by clamping V_p at the breakdown voltage of the Zener diode. However, for the lowest possible V_{cL} , especially when V_p is biased at a voltage significantly below the Zener breakdown voltage, it is recommended that a 0.22µF ceramic chip capacitor be connected between V_p and the ground plane.

As a general rule, the ESD Protection Array should be located as close as possible to the point of entry of expected electrostatic discharges. The power supply bypass capacitor mentioned earlier should be as close to the V_P pin of the Protection Array as possible, with minimum PCB trace lengths to the power supply, ground planes and between the signal input and the ESD device to minimize stray series inductance.

Additional Information

See also California Micro Devices Application Note AP209, "Design Considerations for ESD Protection," in the Applications section at www.calmicro.com.

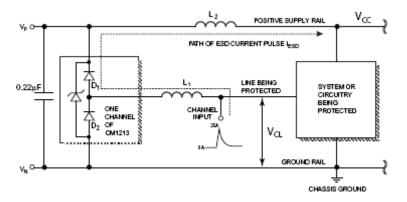


Figure 3. Application of Positive ESD Pulse between Input Channel and Ground

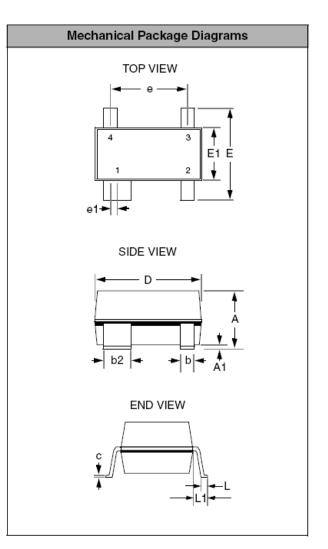
Mechanical Details

The CM1224 is available in SOT143-4, SOT23-6, and MSOP-10 packages with a lad-free finishing option. The various package drawings are presented below.

SOT143-4 Mechanical Specifications

Dimensions for CM1224-02SR devices supplied in 4-pin SOT143 packages are presented below.

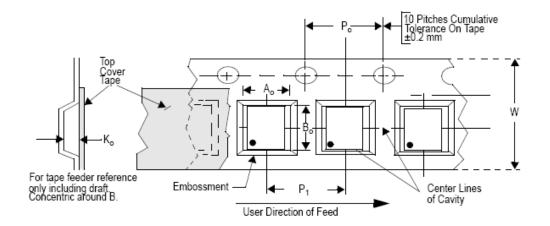
| PACKAGE DIMENSIONS | | | | | | |
|------------------------|--------------|-------------|-------------|-------|--|--|
| Package | | SO | T143 | | | |
| Pins | | | 4 | | | |
| Dimensions | Millir | neters | Inc | ches | | |
| | Min | Max | Min | Max | | |
| Α | 0.80 | 1.22 | 0.031 | 0.048 | | |
| A1 | 0.05 | 0.15 | 0.002 | 0.006 | | |
| b | 0.30 | 0.50 | 0.012 | 0.019 | | |
| b2 | 0.76 | 0.89 | 0.030 | 0.035 | | |
| с | 0.08 | 0.20 | 0.003 | 0.008 | | |
| D | 2.80 | 3.04 | 0.110 | 0.119 | | |
| E | 2.10 | 2.64 | 0.082 | 0.103 | | |
| E1 | 1.20 | 1.40 | 0.047 | 0.055 | | |
| е | 1.92 | BSC | 0.07 | 5 BSC | | |
| e1 | 0.20 |) BSC | 0.008 BS | С | | |
| L | 0.4 | 0.6 | 0.016 | 0.024 | | |
| L1 | 0.54 | 4 REF | 0.021 RE | F | | |
| # per tape and reel | | 3000 | pieces | | | |
| С | ontrolling d | imension: n | nillimeters | | | |



Package Dimensions for SOT143

Tape and Reel Specifications

| PART NUMBER | PACKAGE SIZE (mm) | POCKET SIZE (mm) B ₀ X A ₀ X K ₀ | TAPE WIDTH W | REEL DIAMETER | QTY PER REEL | P₀ | P ₁ |
|-------------|----------------------|--|-----------------|------------------|-----------------|-----|----------------|
| CM1224-02SR | 2.92 X 2.37 X 1.01 | 2.60 X 3.15 X 1.20 | 8mm | 178mm (7") | 3000 | 4mm | 4mm |

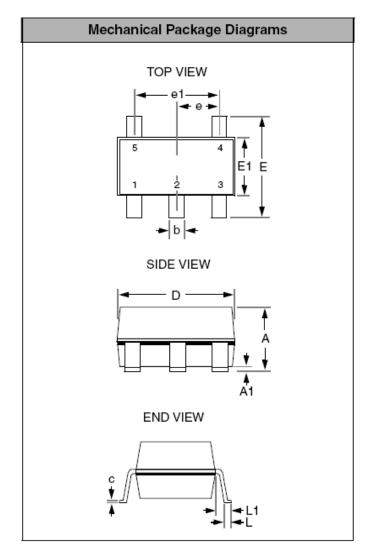


Mechanical Details (cont'd)

SOT23-6 Mechanical Specifications

CM1224-04SO devices are packaged in 6-pin SOT23 packages. Dimensions are presented below.

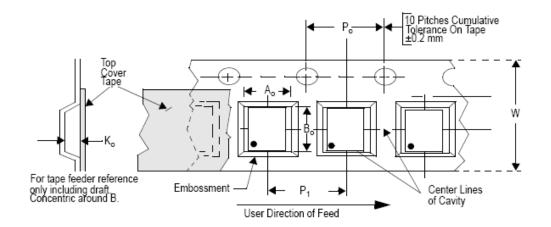
| PACKAGE DIMENSIONS | | | | | | |
|------------------------|--------------|-------------|-------------|---------|--|--|
| Package | SOT2 | 3-6 (JEDEC | name is N | 10-178) | | |
| Pins | | | 6 | | | |
| Dimensions | Millir | neters | Inc | hes | | |
| | Min | Max | Min | Max | | |
| Α | | 1.45 | | 0.0571 | | |
| A1 | 0.00 | 0.15 | 0.0000 | 0.0059 | | |
| b | 0.30 | 0.50 | 0.0118 | 0.0197 | | |
| с | 0.08 | 0.22 | 0.0031 | 0.0087 | | |
| D | 2.75 | 3.05 | 0.1083 | 0.1201 | | |
| E | 2.60 | 3.00 | 0.1024 | 0.1181 | | |
| E1 | 1.45 | 1.75 | 0.0571 | 0.0689 | | |
| е | 0.95 | BSC | 0.037 | '4 BSC | | |
| e1 | 1.90 | BSC | 0.074 | 8 BSC | | |
| L | 0.30 | 0.60 | 0.0118 | 0.0236 | | |
| L1 | 0.60 |) REF | 0.023 | 86 REF | | |
| # per tape and reel | | 3000 | pieces | | | |
| С | ontrolling d | imension: n | nillimeters | | | |



Package Dimensions for SOT23-6

Tape and Reel Specifications

| PART NUMBER | PACKAGE SIZE (mm) | POCKET SIZE (mm) B ₀ X A ₀ X K ₀ | TAPE WIDTH W | REEL DIAMETER | QTY PER REEL | P₀ | P, |
|-------------|----------------------|--|-----------------|------------------|-----------------|-----|-----|
| CM1224-04SO | 2.90 X 2.80 X 1.45 | 3.20 X 3.20 X 1.40 | 8mm | 178mm (7") | 3000 | 4mm | 4mm |

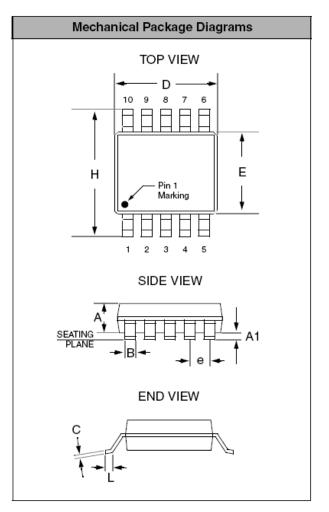


Mechanical Details (cont'd)

MSOP-10 Mechanical Specifications, 10 pin

The CM1224-04MR 10-lead MSOP package dimensions are presented below.

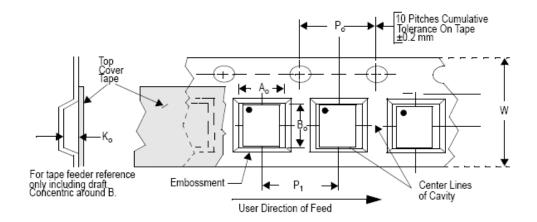
| PACKAGE DIMENSIONS | | | | | | | |
|------------------------|--------------|-------------|-------------|-------|--|--|--|
| Package | | MS | SOP | | | | |
| Pins | | 1 | 10 | | | | |
| Dimensions | Millir | neters | Inc | hes | | | |
| Dimensions | Min | Max | Min | Max | | | |
| Α | 0.75 | 0.95 | 0.028 | 0.038 | | | |
| A1 | 0.05 | 0.15 | 0.002 | 0.006 | | | |
| В | 0.17 | 0.27 | 0.007 | 0.013 | | | |
| с | 0.13 | 0.23 | 0.005 | 0.009 | | | |
| D | 2.90 | 3.10 | 0.114 | 0.122 | | | |
| E | 2.90 | 3.10 | 0.114 | 0.122 | | | |
| е | 0.50 | BSC | 0.019 | 6 BSC | | | |
| н | 4.90 | BSC | 0.193 | 3 BSC | | | |
| L | 0.40 | 0.70 | 0.0137 | 0.029 | | | |
| # per tape and reel | 4000 | | | | | | |
| C | ontrolling d | imension: n | nillimeters | | | | |



Package Dimensions for MSOP-10

Tape and Reel Specifications

| PART NUMBER | PACKAGE SIZE (mm) | POCKET SIZE (mm) B ₀ X A ₀ X K ₀ | TAPE WIDTH W | REEL DIAMETER | QTY PER REEL | P。 | P ₁ |
|-------------|----------------------|--|-----------------|------------------|-----------------|-----|----------------|
| CM1224-04MR | 3.00 X 3.00 X 0.85 | 3.30 X 5.30 X 1.30 | 12mm | 330mm (13") | 4000 | 4mm | 8mm |



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